

REACH, RoHS and Conflict Materials Company Statement

Electronic Assembly Services Ltd has reviewed the operational requirements of the RoHS Directive (2011/65/EU), REACH Regulations (1907/2006) and Conflict Minerals requirements and we fully support and comply with the regulations.

RoHS Statement

Electronic assembly Services is pleased to confirm that, where appropriate, parts ordered into the business will be RoHS compliant. EASL is also able to support non-ROHS builds if required for product that falls out of scope of the Directive. Our Engineering team, purchasers and suppliers are knowledgeable on the requirements of RoHS Directive and will only purchase RoHS compliant parts if required. In addition to this, EASL implements necessary production controls to ensure that RoHS and non-RoHS builds are clearly identified, processed and segregated accordingly.

The RoHS directive restricts the use of certain substances that are hazardous to health:

Lead
Cadmium
Mercury
Hexavalent Chromium
Polybrominated Biphenyls (PBB)
Polybrominated Diphenyl Ethers (PBDE)
Bis(2-ethylhexyl) Phthalate (DEHP)
Butyl Benzyl Phthalate (BBP)
Dibutyl Phthalate (DBP)
Diisobutyl Phthalate (DIBP)

REACH Statement

As a supplier of assembled electronic 'articles' to our customers and as a downstream user of chemical substances in our manufacturing processes we have a full understanding of the requirements of the REACH Directive.

With the exception of products that are specified by the customer as being non-RoHS (containing lead), we do not knowingly export any articles that contain Substances of Very High Concern (SVHC's) that are on the Candidate List and with a concentration greater than 0.1% w/w. We maintain regular contact with our suppliers to avoid the unintentional use of SVHC materials on the REACH Candidate List.

We undertake to keep ourselves and partners informed of REACH and the ECHA Candidate List, as amended, and take the necessary steps to ensure that these substances are not included in the production of electronic 'articles' supplied.

When we are aware that substances on the Candidate List are present, we undertake to ensure they are in concentrations not greater than 0.1% w/w. All declarations are made in good faith based on the information supplied by manufacturers and suppliers to Electronic Assembly Services Ltd.

Conflict Materials

As a supplier of Printed Board Assemblies, Electronic Assembly Services Ltd, (EASL) are aware of our obligations with regards to the laws and regulations regarding Conflict Materials, specifically the Dodd-Frank Wall Street Reform and Consumer Protection Act Section 1502.

EASL does not directly source or process Conflict Materials such as Tin, Tantalum, Tungsten, or Gold but these minerals are contained in a few the parts we procure for our assemblies as specified by our customers.

As part of our reasonable due diligence, EASL has contacted the distributors within our supply chain to verify their continued compliance with the regulations. Based on information received we can declare that our products do not contain Conflict Materials from the Conflict Region.